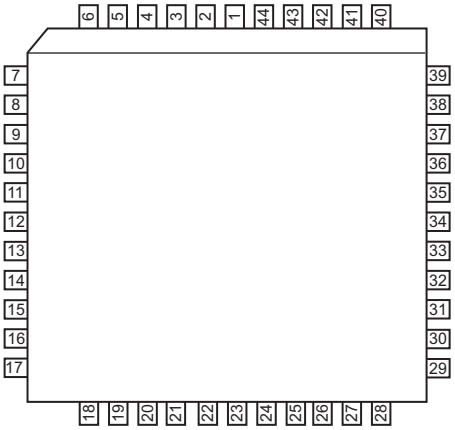
6818

Data Sheet
26182.128D

DABiC-IV, 32-BIT SERIAL-INPUT, LATCHED SOURCE DRIVER

A6818xEP



ABSOLUTE MAXIMUM RATINGS

at T_A = 25°C

Logic Supply Voltage, V_{DD} ..... **7.0 V**
Driver Supply Voltage, V_{BB} ..... **60 V**
Continuous Output Current Range,
I_{OUT} ..... **-40 mA to +15 mA**
Input Voltage Range,
V_{IN} ..... **-0.3 V to V_{DD} + 0.3 V**
Package Power Dissipation,
P_D ..... **See Graph**
Operating Temperature Range, T_A
(Suffix 'E–') ..... **-40°C to +85°C**
(Suffix 'K–') ..... **-40°C to +125°C**
(Suffix 'S–') ..... **-20°C to +85°C**
Storage Temperature Range,
T_S ..... **-55°C to +125°C**

Caution: These CMOS devices have input static protection (Class 2) but are still susceptible to damage if exposed to extremely high static electrical charges.

The A6818– devices combine a 32-bit CMOS shift register, accompanying data latches and control circuitry with bipolar sourcing outputs and pnp active pull downs. Designed primarily to drive vacuum-fluorescent displays, the 60 V and -40 mA output ratings also allow these devices to be used in many other peripheral power driver applications. The A6818– features an increased data input rate (compared with the older UCN/UCQ5818–F) and a controlled output slew rate.

The CMOS shift register and latches allow direct interfacing with microprocessor-based systems. With a 3.3 V or 5 V logic supply, typical serial-data input rates are up to 33 MHz.

A CMOS serial data output permits cascade connections in applications requiring additional drive lines. Similar devices are available as the A6810– (10 bits) and A6812– (20 bits).

The A6818– output source drivers are npn Darlingtons, capable of sourcing up to 40 mA. The controlled output slew rate reduces electromagnetic noise, which is an important consideration in systems that include telecommunications and/or microprocessors and to meet government emissions regulations. For inter-digit blanking, all output drivers can be disabled and all sink drivers turned on with a BLANKING input high. The pnp active pull-downs will sink at least 2.5 mA.

Three temperature ranges are available for optimum performance in commercial (suffix S-), industrial (E-), and extended industrial (K-) applications. The package style provided is the minimum-area surface-mount PLCC (suffix -EP). Copper lead frames, low logic-power dissipation, and low output-saturation voltages allow these devices to drive most multiplexed vacuum-fluorescent displays over the maximum operating temperature range.

The lead (Pb) free versions have 100% matte tin leadframe plating.

FEATURES

- Controlled Output Slew Rate
- 60 V Minimum Output Breakdown
- PNP Active Pull-Downs
- Low-Power CMOS Logic and Latches
- High-Speed Data Storage
- High Data Input Rate
- Low Output-Saturation Voltages
- Improved Replacements for SN75518N, SN75518NF, UCN5818–, and UCQ5818–

Always order by complete part number:

Part Number	Pb-free	Packing	Ambient Temperature, T_A (°C)
A6818EEP	–	27 pieces/tube	–40 to 85
A6818EEP-T	Yes		
A6818EEPTR	–	450 pieces/13-in. reel	
A6818EEPTR-T	Yes		
A6818KEP	–	27 pieces/tube	–40 to 125
A6818KEP-T	Yes		
A6818KEPTR	–	450 pieces/13-in. reel	
A6818KEPTR-T	Yes		
A6818SEP	–	27 pieces/tube	–20 to 85
A6818SEP-T	Yes		
A6818SEPTR	–	450 pieces/13-in. reel	
A6818SEPTR-T	Yes		

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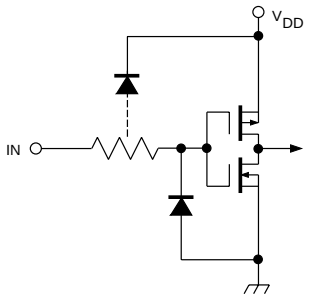
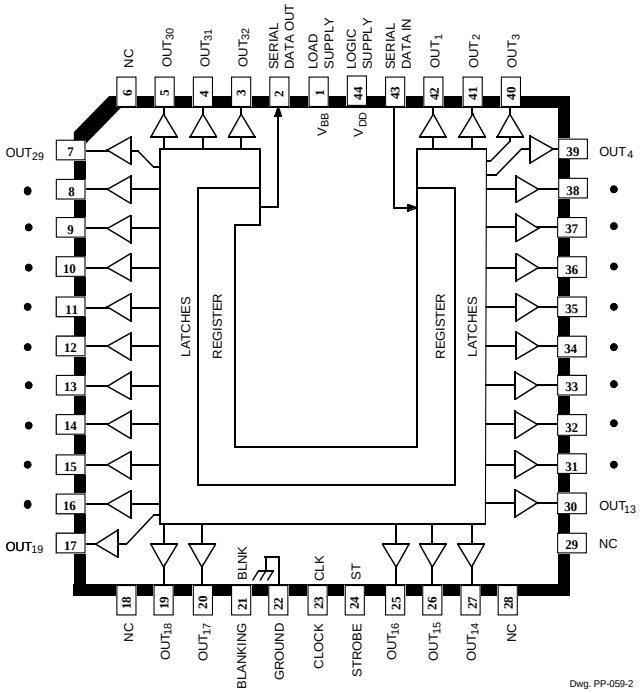
6818
32-BIT SERIAL-INPUT, LATCHED SOURCE DRIVER

TYPICAL INPUT CIRCUIT



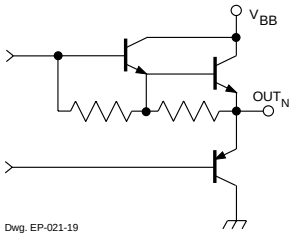
Dwg. EP-010-5

A6818xEP



Dwg. PP-059-2

TYPICAL OUTPUT DRIVER



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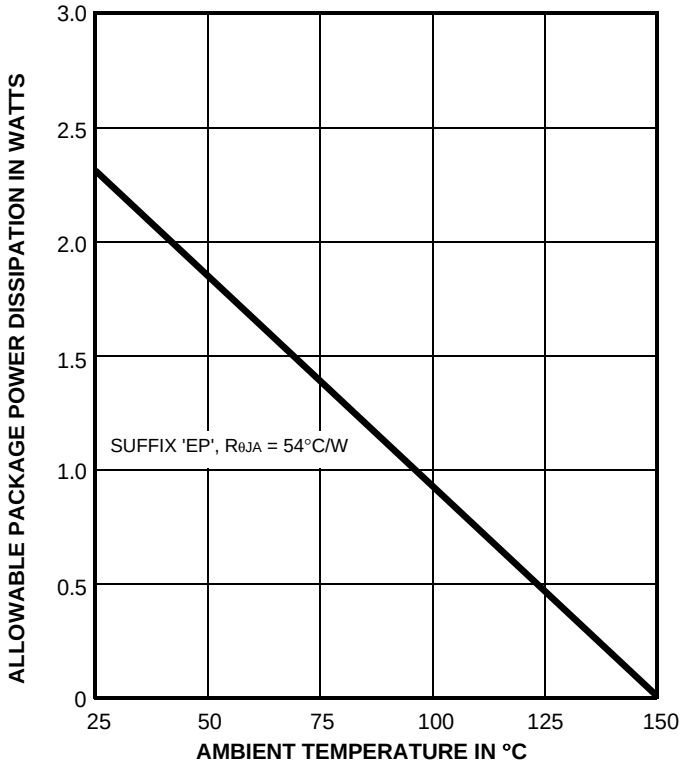

Dwg. GP-025B

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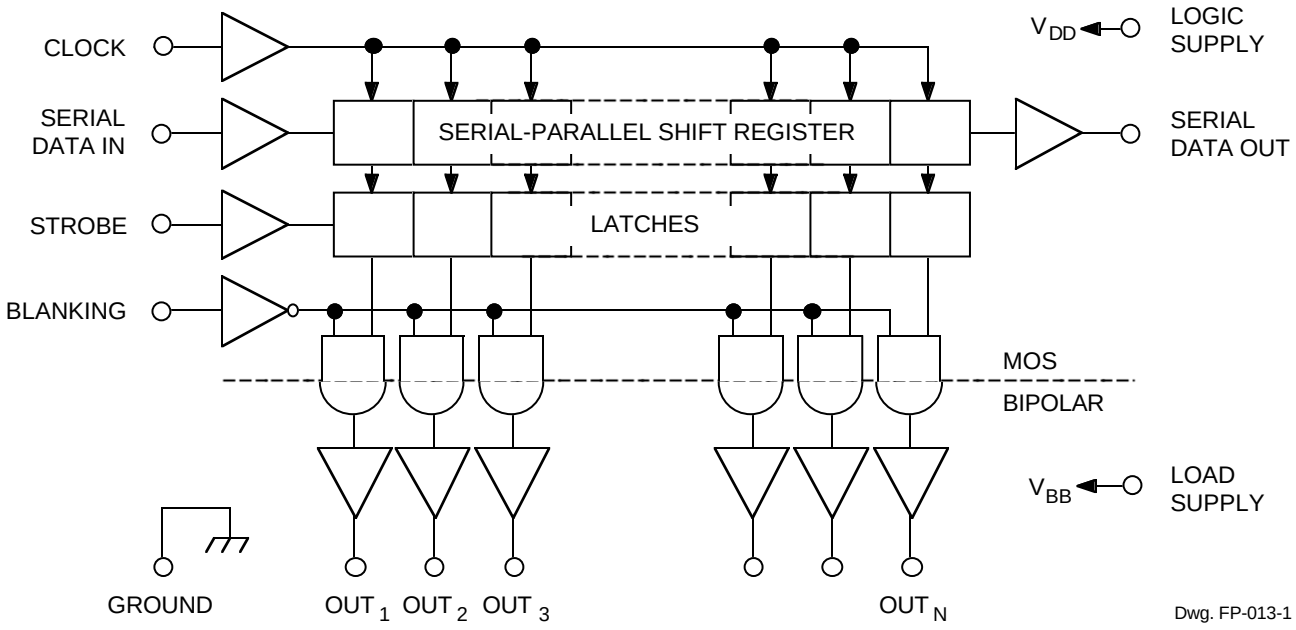
FUNCTIONAL BLOCK DIAGRAM



TRUTH TABLE

Serial Data Input	Clock Input	Shift Register Contents	Serial Data Output	Strobe Input	Latch Contents	Blanking	Output Contents
		I_1 I_2 I_3 ... I_{N-1} I_N			I_1 I_2 I_3 ... I_{N-1} I_N		I_1 I_2 I_3 ... I_{N-1} I_N
H	⌐	H R_1 R_2 ... R_{N-2} R_{N-1}	R_{N-1}				
L	⌐	L R_1 R_2 ... R_{N-2} R_{N-1}	R_{N-1}				
X	⌐	R_1 R_2 R_3 ... R_{N-1} R_N	R_N				
		X X X ... X X	X	L	R_1 R_2 R_3 ... R_{N-1} R_N		
		P_1 P_2 P_3 ... P_{N-1} P_N	P_N	H	P_1 P_2 P_3 ... P_{N-1} P_N	L	P_1 P_2 P_3 ... P_{N-1} P_N
					X X X ... X X	H	L L L ... L L

L = Low Logic Level H = High Logic Level X = Irrelevant P = Present State R = Previous State

ELECTRICAL CHARACTERISTICS at T_A = +25°C (A6818S-) or over operating temperature range (A6818E- and A6818K-), V_{BB} = 60 V unless otherwise noted.

Characteristic	Symbol	Test Conditions	Limits @ V_{DD} = 3.3 V			Limits @ V_{DD} = 5 V			Units
			Mln.	Typ.	Max.	Min.	Typ.	Max.	
Output Leakage Current	I_{CEX}	V_{OUT} = 0 V	—	<-0.1	-15	—	<-0.1	-15	µA
Output Voltage	$V_{OUT(1)}$	I_{OUT} = -25 mA	57.5	58.3	—	57.5	58.3	—	V
	$V_{OUT(0)}$	I_{OUT} = 1 mA	—	1.0	1.5	—	1.0	1.5	V
Output Pull-Down Current	$I_{OUT(0)}$	V_{OUT} = 5 V to V_{BB}	2.5	5.0	—	2.5	5.0	—	mA
Input Voltage	$V_{IN(1)}$		2.2	—	—	3.3	—	—	V
	$V_{IN(0)}$		—	—	1.1	—	—	1.7	V
Input Current	$I_{IN(1)}$	V_{IN} = V_{DD}	—	<0.01	1.0	—	<0.01	1.0	µA
	$I_{IN(0)}$	V_{IN} = 0.8 V	—	<-0.01	-1.0	—	<-0.01	-1.0	µA
Input Clamp Voltage	V_{IK}	I_{IN} = -200 µA	—	-0.8	-1.5	—	-0.8	-1.5	V
Serial Data Output Voltage	$V_{OUT(1)}$	I_{OUT} = -200 µA	2.8	3.05	—	4.5	4.75	—	V
	$V_{OUT(0)}$	I_{OUT} = 200 µA	—	0.15	0.3	—	0.15	0.3	V
Maximum Clock Frequency	f_c		10	33	—	10	33	—	MHz
Logic Supply Current	$I_{DD(1)}$	All Outputs High	—	0.25	0.75	—	0.3	1.0	mA
	$I_{DD(0)}$	All Outputs Low	—	0.25	0.75	—	0.3	1.0	mA
Load Supply Current	$I_{BB(1)}$	All Outputs High, No Load	—	4.5	9.0	—	4.5	9.0	mA
	$I_{BB(0)}$	All Outputs Low	—	0.2	20	—	0.2	20	µA
Blanking-to-Output Delay	$t_{dis(BQ)}$	C_L = 30 pF, 50% to 50%	—	0.7	2.0	—	0.7	2.0	µs
	$t_{en(BQ)}$	C_L = 30 pF, 50% to 50%	—	1.8	3.0	—	1.8	3.0	µs
Strobe-to-Output Delay	$t_{p(STH-QL)}$	R_L = 2.3 kΩ, C_L ≤ 30 pF	—	0.7	2.0	—	0.7	2.0	µs
	$t_{p(STH-QH)}$	R_L = 2.3 kΩ, C_L ≤ 30 pF	—	1.8	3.0	—	1.8	3.0	µs
Output Fall Time	t_f	R_L = 2.3 kΩ, C_L ≤ 30 pF	2.4	—	12	2.4	—	12	µs
Output Rise Time	t_r	R_L = 2.3 kΩ, C_L ≤ 30 pF	2.4	—	12	2.4	—	12	µs
Output Slew Rate	dV/dt	R_L = 2.3 kΩ, C_L ≤ 30 pF	4.0	—	20	4.0	—	20	V/µs
Clock-to-Serial Data Out Delay	$t_{p(CH-SQX)}$	I_{OUT} = ±200 µA	—	50	—	—	50	—	ns

Negative current is defined as coming out of (sourcing) the specified device terminal.

Typical data is is for design information only and is at T_A = +25°C.

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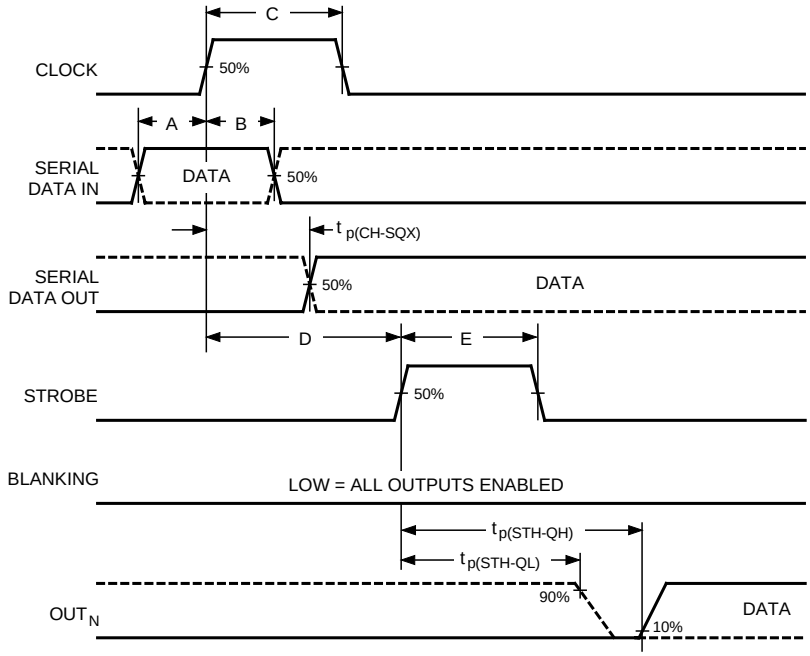
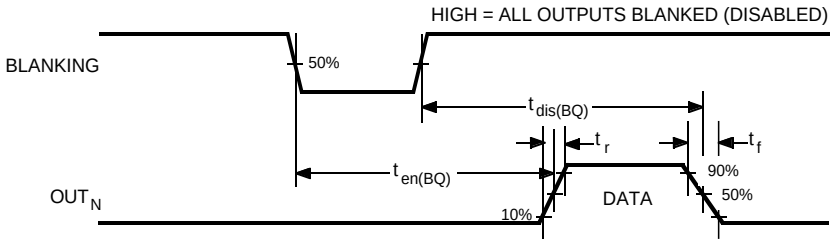
TIMING REQUIREMENTS and SPECIFICATIONS

(Logic Levels are V_{DD} and Ground)



Dwg. WP-029



Dwg. WP-030A

A. Data Active Time Before Clock Pulse (Data Set-Up Time), $t_{su(D)}$ ..... **25 ns**

B. Data Active Time After Clock Pulse (Data Hold Time), $t_{h(D)}$ ..... **25 ns**

C. Clock Pulse Width, $t_{w(CH)}$ ..... **50 ns**

D. Time Between Clock Activation and Strobe, $t_{su(C)}$ ..... **100 ns**

E. Strobe Pulse Width, $t_{w(STH)}$ ..... **50 ns**

NOTE – Timing is representative of a 10 MHz clock. Significantly higher speeds are attainable.

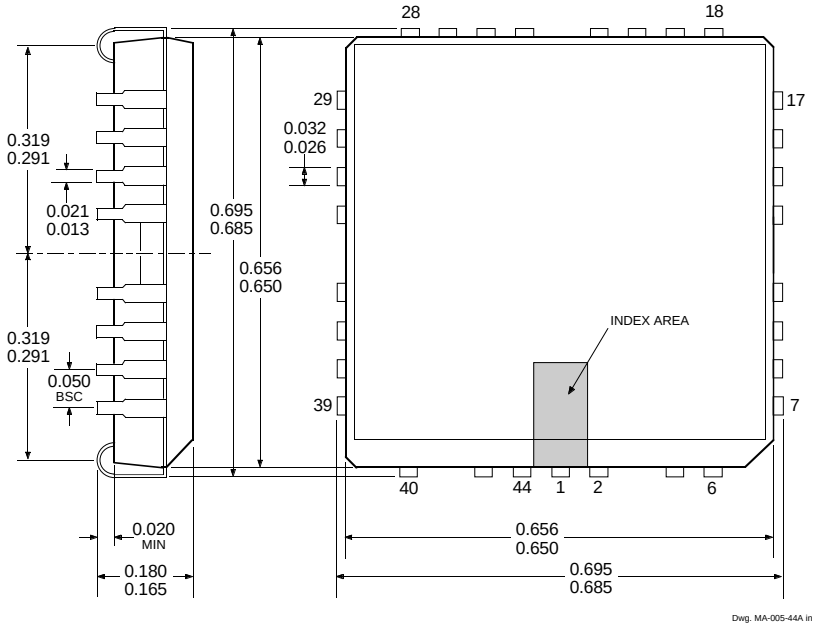
Serial Data present at the input is transferred to the shift register on the logic "0" to logic "1" transition of the CLOCK input pulse. On succeeding CLOCK pulses, the registers shift data information towards the SERIAL DATA OUTPUT. The SERIAL DATA must appear at the input prior to the rising edge of the CLOCK input waveform.

Information present at any register is transferred to the respective latch when the STROBE is high (serial-to-parallel conversion). The latches will continue to accept new data as long as the STROBE is held high. Applications where the latches are bypassed (STROBE tied high) will require that the BLANKING input be high during serial data entry.

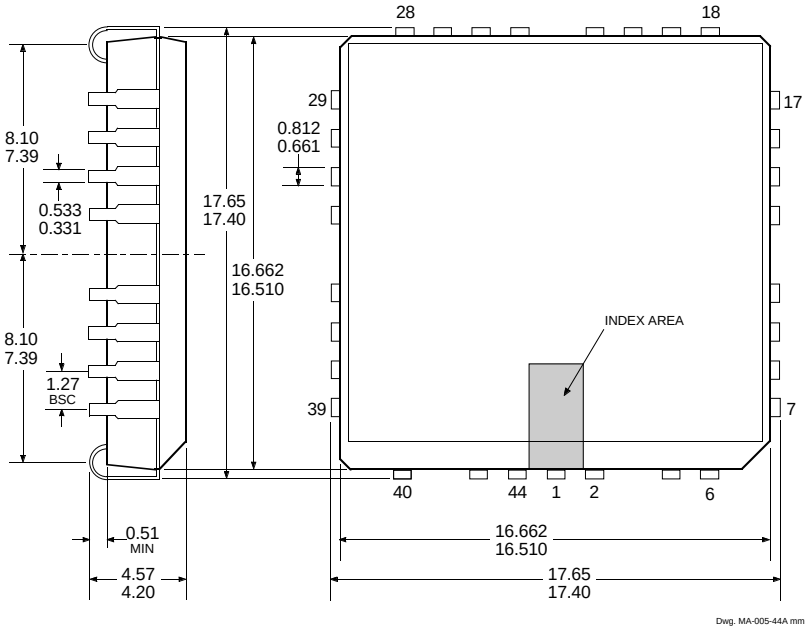
When the BLANKING input is high, the output source drivers are disabled (OFF); the pnp active pull-down sink drivers are ON. The information stored in the latches is not affected by the BLANKING input. With the BLANKING input low, the outputs are controlled by the state of their respective latches.

A6818EEP & A6818SEP

Dimensions in Inches
(controlling dimensions)



Dimensions in Millimeters
(for reference only)



NOTES: 1. Exact body and lead configuration at vendor's option within limits shown.
2. Lead spacing tolerance is non-cumulative.

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32-BIT SERIAL-INPUT, LATCHED SOURCE DRIVER

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